

16 Mbit (2Mb x8 or 1Mb x16) UV EPROM and OTP EPROM

- 5V ± 10% SUPPLY VOLTAGE in READ OPERATION
- FAST ACCESS TIME: 70ns
- BYTE-WIDE or WORD-WIDE CONFIGURABLE
- 16 Mbit MASK ROM REPLACEMENT
- LOW POWER CONSUMPTION
 - Active Current 70mA at 8MHz
 - Standby Current 100μA
- PROGRAMMING VOLTAGE: 12.5V ± 0.25V
 PROGRAMMING TIME: 100µs/byte (typical)
- ELECTRONIC SIGNATUREManufacturer Code: 0020h
 - Device Code: 00B1h

DESCRIPTION

The M27C160 is a 16 Mbit EPROM offered in the two ranges UV (ultra violet erase) and OTP (one time programmable). It is ideally suited for microprocessor systems requiring large data or program storage and is organised as either 2 Mbit words of 8 bit or 1 Mbit words of 16 bit. The pin-out is compatible with a 16 Mbit Mask ROM.

The FDIP42W (window ceramic frit-seal package) has a transparent lid which allows the user to expose the chip to ultraviolet light to erase the bit pattern.

Table 1. Signal Names

| A0-A19 | Address Inputs |
|---------------------|-----------------------------|
| Q0-Q7 | Data Outputs |
| Q8-Q14 | Data Outputs |
| Q15A-1 | Data Output / Address Input |
| Ē | Chip Enable |
| G | Output Enable |
| BYTEV _{PP} | Byte Mode / Program Supply |
| Vcc | Supply Voltage |
| V _{SS} | Ground |

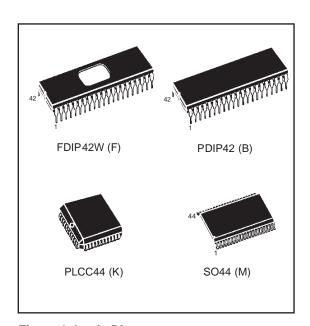
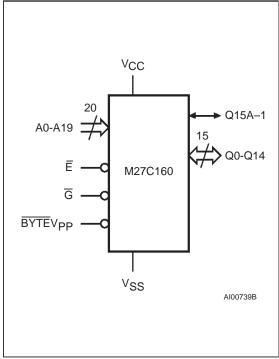


Figure 1. Logic Diagram



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Figure 2A. DIP Pin Connections

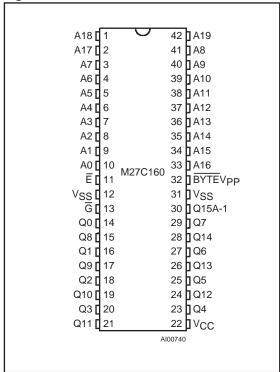


Figure 2C. SO Pin Connections

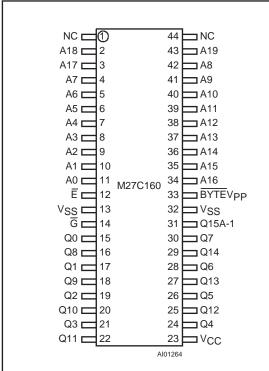
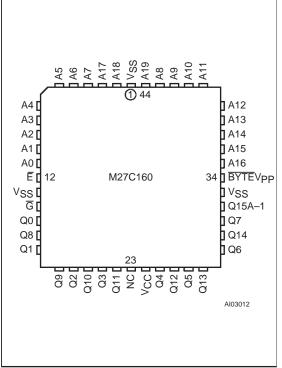


Figure 2B. PLCC Pin Connections



Warning: NC = Not Connected.

A new pattern can then be written rapidly to the device by following the programming procedure.

For applications where the content is programmed only one time and erasure is not required, the M27C160 is offered in PDIP42, PLCC44 and SO44 packages.

DEVICE OPERATION

The operating modes of the M27C160 are listed in the Operating Modes Table. A single power supply is required in the read mode. All inputs are TTL compatible except for VPP and 12V on A9 for the Electronic Signature.

Read Mode

The M27C160 has two organisations, Word-wide and Byte-wide. The organisation is selected by the signal level on the $\overline{BYTE}V_{PP}$ pin. When $\overline{BYTE}V_{PP}$ is at V_{IH} the Word-wide organisation is selected and the Q15A–1 pin is used for Q15 Data Output. When the $\overline{BYTE}V_{PP}$ pin is at V_{IL} the Byte-wide organisation is selected and the Q15A–1 pin is used for the Address Input A–1. When the memory is logically regarded as 16 bit wide, but read in the Byte-wide organisation, then with A–1 at V_{IL} the lower 8 bits of the 16 bit data are selected and with A–1 at V_{IH} the upper 8 bits of the 16 bit data are selected.

Table 2. Absolute Maximum Ratings (1)

| Symbol | Parameter | Value | Unit |
|--------------------------------|-------------------------------------|------------|------|
| TA | Ambient Operating Temperature (3) | -40 to 125 | °C |
| T _{BIAS} | Temperature Under Bias | -50 to 125 | °C |
| T _{STG} | Storage Temperature | -65 to 150 | °C |
| V _{IO} (2) | Input or Output Voltage (except A9) | –2 to 7 | V |
| Vcc | Supply Voltage | –2 to 7 | V |
| V _{A9} ⁽²⁾ | A9 Voltage | -2 to 13.5 | V |
| VPP | Program Supply Voltage | –2 to 14 | V |

Note: 1. Except for the rating "Operating Temperature Range", stresses above those listed in the Table "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 3. Operating Modes

| Mode | Ē | G | BYTEVPP | A9 | Q0-Q7 | Q8-Q14 | Q15A-1 |
|----------------------|-----------------------|-----------------|-----------------|-----------------|----------|----------|-----------------|
| Read Word-wide | V _{IL} | V _{IL} | V _{IH} | Х | Data Out | Data Out | Data Out |
| Read Byte-wide Upper | V _{IL} | V _{IL} | V _{IL} | Х | Data Out | Hi-Z | V _{IH} |
| Read Byte-wide Lower | VIL | V _{IL} | V _{IL} | Х | Data Out | Hi-Z | V _{IL} |
| Output Disable | VIL | ViH | Х | Х | Hi-Z | Hi-Z | Hi-Z |
| Program | V _{IL} Pulse | V _{IH} | V_{PP} | Х | Data In | Data In | Data In |
| Verify | V _{IH} | V _{IL} | V_{PP} | Х | Data Out | Data Out | Data Out |
| Program Inhibit | V _{IH} | V _{IH} | V _{PP} | Х | Hi-Z | Hi-Z | Hi-Z |
| Standby | V _{IH} | Х | Х | Х | Hi-Z | Hi-Z | Hi-Z |
| Electronic Signature | V _{IL} | V _{IL} | V _{IH} | V _{ID} | Codes | Codes | Code |

Note: $X = V_{IH}$ or V_{IL} , $V_{ID} = 12V \pm 0.5V$.

Table 4. Electronic Signature

| Identifier | A0 | Q7 | Q6 | Q5 | Q4 | Q3 | Q2 | Q1 | Q0 | Hex Data |
|---------------------|-----------------|----|----|----|----|----|----|----|----|----------|
| Manufacturer's Code | V _{IL} | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 20h |
| Device Code | V _{IH} | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | B1h |

Note: Outputs Q8-Q15 are set to '0'.

The M27C160 has two control functions, both of which must be logically active in order to obtain data at the outputs. In addition the Word-wide or Byte- wide organisation must be selected.

Chip Enable (\overline{E}) is the power control and should be used for device selection. Output Enable (\overline{G}) is the output control and should be used to gate data to

the output pins independent of device selection. Assuming that the addresses are stable, the address access time (t_{AVQV}) is equal to the delay from \overline{E} to output (t_{ELQV}) . Data is available at the output after a delay of t_{GLQV} from the falling edge of \overline{G} , assuming that \overline{E} has been low and the addresses have been stable for at least t_{AVQV} - t_{GLQV} .



^{2.} Minimum DC voltage on Input or Output is -0.5V with possible undershoot to -2.0V for a period less than 20ns. Maximum DC voltage on Output is V_{CC} +0.5V with possible overshoot to V_{CC} +2V for a period less than 20ns.

^{3.} Depends on range.

Table 5. AC Measurement Conditions

| | High Speed | Standard |
|---------------------------------------|------------|--------------|
| Input Rise and Fall Times | ≤ 10ns | ≤ 20ns |
| Input Pulse Voltages | 0 to 3V | 0.4V to 2.4V |
| Input and Output Timing Ref. Voltages | 1.5V | 0.8V and 2V |

Figure 3. Testing Input Output Waveform

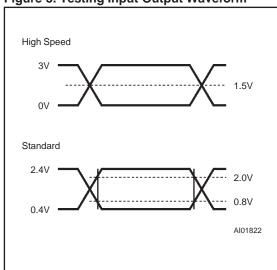


Figure 4. AC Testing Load Circuit

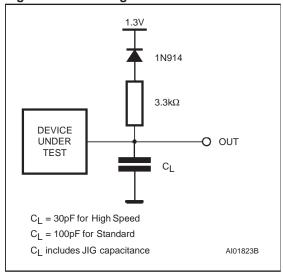


Table 6. Capacitance ⁽¹⁾ $(T_A = 25 \, {}^{\circ}C, f = 1 \, MHz)$

| Symbol | Parameter | Test Condition | Min | Max | Unit |
|------------------|---|-----------------------|-----|-----|------|
| C _{IN} | Input Capacitance (except BYTEV _{PP}) | $V_{IN} = 0V$ | | 10 | pF |
| OIN | Input Capacitance (BYTEV _{PP}) | V _{IN} = 0V | | 120 | pF |
| C _{OUT} | Output Capacitance | V _{OUT} = 0V | | 12 | pF |

Note: 1. Sampled only, not 100% tested.

Standby Mode

The M27C160 has a standby mode which reduces the active current from 50mA to 100 μ A. The M27C160 is placed in the standby mode by applying a CMOS high signal to the \overline{E} input. When in the standby mode, the outputs are in a high impedance state, independent of the \overline{G} input.

Two Line Output Control

Because EPROMs are usually used in larger memory arrays, this product features a 2 line control function which accommodates the use of multiple memory connection. The two line control function allows:

- a. the lowest possible memory power dissipation,
- b. complete assurance that output bus contention will not occur.

For the most efficient use of these two control lines, \overline{E} should be decoded and used as the primary device selecting function, while \overline{G} should be made a common connection to all devices in the array and connected to the \overline{READ} line from the system control bus. This ensures that all deselected memory devices are in their low power standby mode and that the output pins are only active when data is required from a particular memory device.

Table 7. Read Mode DC Characteristics (1)

 $(T_A = 0 \text{ to } 70 \text{ °C or } -40 \text{ to } 85 \text{ °C}; V_{CC} = 5V \pm 5\% \text{ or } 5V \pm 10\%; V_{PP} = V_{CC})$

| Symbol | Parameter | Test Condition | Min | Max | Unit |
|--------------------------------|-------------------------------|---|------|---------------------|------|
| ILI | Input Leakage Current | $0V \le V_{IN} \le V_{CC}$ | | ±1 | μΑ |
| I _{LO} | Output Leakage Current | 0V ≤ V _{OUT} ≤ V _{CC} | | ±10 | μΑ |
| Loo Supply Current | | $\overline{E} = V_{IL}, \overline{G} = V_{IL},$ $I_{OUT} = 0$ mA, $f = 8$ MHz | | 70 | mA |
| I _{CC} Supp | Supply Current | $\overline{E} = V_{IL}, \overline{G} = V_{IL},$ $I_{OUT} = 0mA, f = 5MHz$ | | 50 | mA |
| I _{CC1} | Supply Current (Standby) TTL | E = V _{IH} | | 1 | mA |
| I _{CC2} | Supply Current (Standby) CMOS | $\overline{E} > V_{CC} - 0.2V$ | | 100 | μΑ |
| I _{PP} | Program Current | $V_{PP} = V_{CC}$ | | 10 | μΑ |
| VIL | Input Low Voltage | | -0.3 | 0.8 | V |
| V _{IH} ⁽²⁾ | Input High Voltage | | 2 | V _{CC} + 1 | V |
| V _{OL} | Output Low Voltage | I _{OL} = 2.1mA | | 0.4 | ٧ |
| V _{OH} | Output High Voltage TTL | I _{OH} = -400μA | 2.4 | | V |

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.

2. Maximum DC voltage on Output is V_{CC} +0.5V.

System Considerations

The power switching characteristics of Advanced CMOS EPROMs require carefull decoupling of the supplies to the devices. The supply current I_{CC} has three segments of importance to the system designer: the standby current, the active current and the transient peaks that are produced by the falling and rising edges of \overline{E} .

The magnitude of the transient current peaks is dependant on the capacititive and inductive loading of the device outputs. The associated transient voltage peaks can be supressed by complying with the two line output control and by properly selected decoupling capacitors. It is recommended that a $0.1\mu F$ ceramic capacitor is used on every device between V_{CC} and V_{SS} . This should be a high frequency type of low inherent inductance and should be placed as close as possible to the device. In addition, a $4.7\mu F$ electrolytic capacitor should be used between V_{CC} and V_{SS} for every eight devices.

This capacitor should be mounted near the power supply connection point. The purpose of this capacitor is to overcome the voltage drop caused by the inductive effects of PCB traces.

Programming

When delivered (and after each erasure for UV EPROM), all bits of the M27C160 are in the '1' state. Data is introduced by selectively programming '0's into the desired bit locations. Although only '0's will be programmed, both '1's and '0's can be present in the data word. The only way to change a '0' to a '1' is by die exposition to ultraviolet light (UV EPROM). The M27C160 is in the programming mode when V_{PP} input is at 12.5V, \overline{G} is at V_{IH} and \overline{E} is pulsed to V_{IL} . The data to be programmed is applied to 16 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL. V_{CC} is specified to be $6.25 \text{V} \pm 0.25 \text{V}$.

Table 8. Read Mode AC Characteristics ⁽¹⁾ (T_A = 0 to 70 °C or -40 to 85 °C; V_{CC} = 5V \pm 5% or 5V \pm 10%; V_{PP} = V_{CC})

| | | | | | | | M270 | C160 | | | | |
|-----------------------|------------------|---|--|-----|-----|-----|------|------|-----|------|-------|------|
| Symbol | Alt | Parameter | Test Condition | -70 | (3) | -6 | 90 | -1 | 00 | -120 | /-150 | Unit |
| | | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{AVQV} | t _{ACC} | Address Valid to Output Valid | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | | 70 | | 90 | | 100 | | 120 | ns |
| t _{BHQV} | t _{ST} | BYTE High to Output Valid | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | | 70 | | 90 | | 100 | | 120 | ns |
| t _{ELQV} | t _{CE} | Chip Enable Low to Output Valid | $\overline{G} = V_{IL}$ | | 70 | | 90 | | 100 | | 120 | ns |
| t _{GLQV} | t _{OE} | Output Enable Low to Output Valid | $\overline{E} = V_{IL}$ | | 35 | | 45 | | 50 | | 60 | ns |
| t _{BLQZ} (2) | t _{STD} | BYTE Low to Output Hi-Z | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | | 30 | | 30 | | 40 | | 50 | ns |
| t _{EHQZ} (2) | t _{DF} | Chip Enable High to Output Hi-Z | $\overline{G} = V_{IL}$ | 0 | 25 | 0 | 30 | 0 | 40 | 0 | 50 | ns |
| t _{GHQZ} (2) | t _{DF} | Output Enable High to OutputHi-Z | E = V _{IL} | 0 | 25 | 0 | 30 | 0 | 40 | 0 | 50 | ns |
| t _{AXQX} | t _{OH} | Address Transition to Output Transition | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | 5 | | 5 | | 5 | | 5 | | ns |
| t _{BLQX} | t _{OH} | BYTE Low to Output Transition | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | 5 | | 5 | | 5 | | 5 | | ns |

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP} 2. Sampled only, not 100% tested.

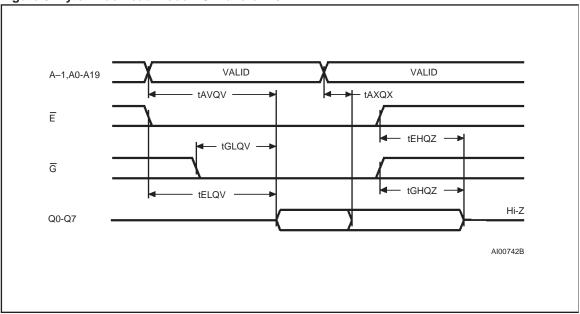
3. Speed obtained with High Speed Measurement Conditions and V_{CC} = 5V \pm 5%.

VALID VALID A0-A19 tAVQV -- tAXQX Ē - tEHQZ → - tGLQV -G - tGHQZ tELQV -Hi-Z Q0-Q15 AI00741B

Figure 5. Word-Wide Read Mode AC Waveforms

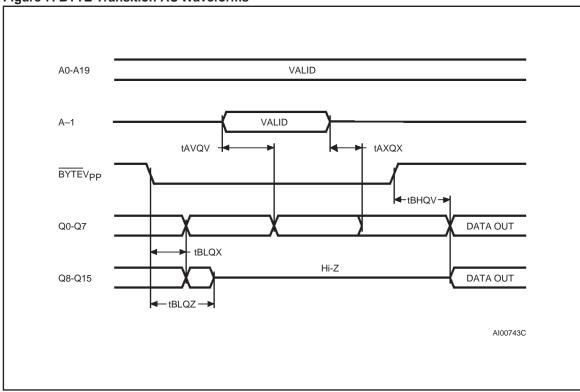
Note: BYTEV_{PP} = V_{IH}.

Figure 6. Byte-Wide Read Mode AC Waveforms



Note: BYTEV_{PP} = V_{IL}.

Figure 7. BYTE Transition AC Waveforms



Note: Chip Enable (\overline{E}) and Output Enable $(\overline{G}) = V_{IL}$.



Table 9. Programming Mode DC Characteristics (1) (T_A = 25 °C; V_{CC} = 6.25V \pm 0.25V; V_{PP} = 12.5V \pm 0.25V)

| Symbol | Parameter | Test Condition | Min | Max | Unit |
|-----------------|-------------------------|---------------------------|------|-----------------------|------|
| ILI | Input Leakage Current | $0 \le V_{IN} \le V_{CC}$ | | ±1 | μΑ |
| Icc | Supply Current | | | 50 | mA |
| I _{PP} | Program Current | E = V _{IL} | | 50 | mA |
| VIL | Input Low Voltage | | -0.3 | 0.8 | V |
| V _{IH} | Input High Voltage | | 2.4 | V _{CC} + 0.5 | V |
| V _{OL} | Output Low Voltage | I _{OL} = 2.1mA | | 0.4 | V |
| V _{OH} | Output High Voltage TTL | I _{OH} = -2.5mA | 3.5 | | V |
| V _{ID} | A9 Voltage | | 11.5 | 12.5 | V |

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.

Table 10. Programming Mode AC Characteristics ⁽¹⁾ $(T_A = 25 \, ^{\circ}C; \, V_{CC} = 6.25 \, V \pm 0.25 \, V; \, V_{PP} = 12.5 \, V \pm 0.25 \, V)$

| Symbol | Alt | Parameter | Test Condition | Min | Max | Unit |
|-----------------------|-----------------|---|----------------|-----|-----|------|
| t _{AVEL} | t _{AS} | Address Valid to Chip Enable Low | | 2 | | μs |
| t _{QVEL} | t _{DS} | Input Valid to Chip Enable Low | | 2 | | μs |
| tvphav | typs | V _{PP} High to Address Valid | | 2 | | μs |
| tvchav | tvcs | V _{CC} High to Address Valid | | 2 | | μs |
| teleh | t _{PW} | Chip Enable Program Pulse Width | | 45 | 55 | μs |
| tEHQX | t _{DH} | Chip Enable High to Input Transition | | 2 | | μs |
| t _{QXGL} | toes | Input Transition to Output Enable Low | | 2 | | μs |
| tGLQV | toe | Output Enable Low to Output Valid | | | 120 | ns |
| t _{GHQZ} (2) | tDFP | Output Enable High to Output Hi-Z | | 0 | 130 | ns |
| t _{GHAX} | t _{AH} | Output Enable High to Address Transition | | 0 | | ns |

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.
2. Sampled only, not 100% tested.

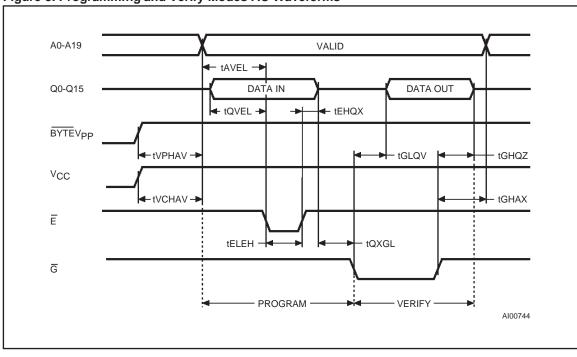
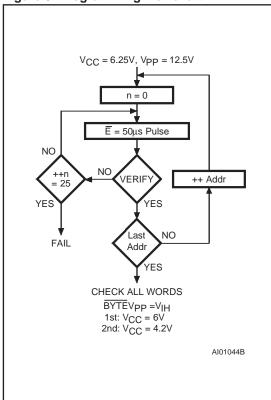


Figure 8. Programming and Verify Modes AC Waveforms

Figure 9. Programming Flowchart



PRESTO III Programming Algorithm

The PRESTO III Programming Algorithm allows the whole array to be programed with a guaranteed margin in a typical time of 52.5 seconds. Programming with PRESTO III consists of applying a sequence of 50µs program pulses to each word until a correct verify occurs (see Figure 9). During programing and verify operation a MARGIN MODE circuit is automatically activated to guarantee that each cell is programed with enough margin. No overprogram pulse is applied since the verify in MARGIN MODE provides the neccessary margin to each programmed cell.

Program Inhibit

Programming of multiple M27C160s in parallel with different data is also easily accomplished. Except for \overline{E} , all like inputs including \overline{G} of the parallel M27C160 may be common. A TTL low level pulse applied to a M27C160's \overline{E} input and V_{PP} at 12.5V, will program that M27C160. A high level \overline{E} input inhibits the other M27C160s from being programmed.

Program Verify

A verify (read) should be performed on the programmed bits to determine that they were correctly programmed. The verify is accomplished with \overline{E} at V_{IH} and \overline{G} at V_{IL}, V_{PP} at 12.5V and V_{CC} at 6.25V.

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On-Board Programming

The M27C160 can be directly programmed in the application circuit. See the relevant Application Note AN620.

Electronic Signature

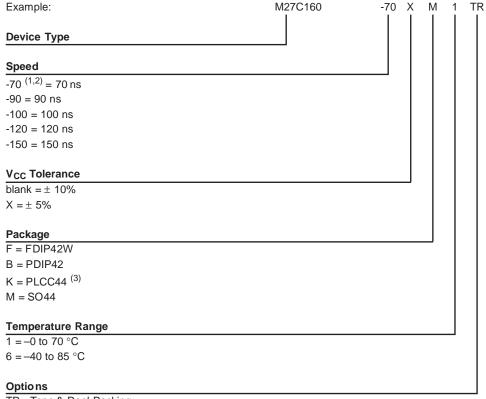
The Electronic Signature (ES) mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and type. This mode is intended for use by programming equipment to automatically match the device to be programmed with its corresponding programming algorithm. The ES mode is functional in the 25°C ± 5°C ambient temperature range that is required when programming the M27C160. To activate the ES mode, the programming equipment must force 11.5V to 12.5V on address line A9 of the M27C160, with V_{PP}=V_{CC}=5V. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from V_{IL} to V_{IH}. All other address lines must be held at V_{IL} during Electronic Signature mode.

Byte 0 ($A0=V_{IL}$) represents the manufacturer code and byte 1 ($A0=V_{IH}$) the device identifier code. For the STMicroelectronics M27C160, these two identifier bytes are given in Table 4 and can be readout on outputs Q0 to Q7.

ERASURE OPERATION (applies to UV EPROM)

The erasure characteristics of the M27C160 is such that erasure begins when the cells are exposed to light with wavelengths shorter than approximately 4000 Å. It should be noted that sunlight and some type of fluorescent lamps have wavelengths in the 3000-4000 Å range. Research shows that constant exposure to room level fluorescent lighting could erase a typical M27C160 in about 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the M27C160 is to be exposed to these types of lighting conditions for extended periods of time, it is suggested that opaque labels be put over the M27C160 window to prevent unintentional erasure. The recommended erasure procedure for M27C160 is exposure to short wave ultraviolet light which has a wavelength of 2537 Å. The integrated dose (i.e. UV intensity x exposure time) for erasure should be a minimum of 30 W-sec/cm² The erasure time with this dosage is approximately 30 to 40 minutes using an ultraviolet lamp with 12000 μ W/cm² power rating. The M27C160 should be placed within 2.5cm (1 inch) of the lamp tubes during the erasure. Some lamps have a filter on their tubes which should be removed before erasure.

Table 11. Ordering Information Scheme



TR =Tape & Reel Packing

Note: 1. High Speed, see AC Characteristics section for further information.

- 2. This speed is guaranteed at V_{CC} = 5V \pm 5%.
- 3. The M27C160 product in PLCC44 package version is offered in the Temperature Range 0 to 70 °C only.

For a list of available options (Speed, Package, etc...) or for further information on any aspect of this device, please contact the ST Sales Office nearest to you.

Table 12. FDIP42W - 42 pin Ceramic Frit-seal DIP, with window, Package Mechanical Data

| Symb | | mm | | | inches | |
|--------|-------|-------|-------|-------|--------|-------|
| Syllib | Тур | Min | Max | Тур | Min | Max |
| Α | | | 5.72 | | | 0.225 |
| A1 | | 0.51 | 1.40 | | 0.020 | 0.055 |
| A2 | | 3.91 | 4.57 | | 0.154 | 0.180 |
| А3 | | 3.89 | 4.50 | | 0.153 | 0.177 |
| В | | 0.41 | 0.56 | | 0.016 | 0.022 |
| B1 | 1.45 | - | - | 0.057 | - | - |
| С | | 0.23 | 0.30 | | 0.009 | 0.012 |
| D | | 54.41 | 54.86 | | 2.142 | 2.160 |
| D2 | 50.80 | - | - | 2.000 | - | - |
| Е | 15.24 | - | - | 0.600 | - | - |
| E1 | | 14.50 | 14.90 | | 0.571 | 0.587 |
| е | 2.54 | _ | - | 0.100 | - | - |
| eA | 14.99 | _ | - | 0.590 | - | - |
| eВ | | 16.18 | 18.03 | | 0.637 | 0.710 |
| L | | 3.18 | | | 0.125 | |
| S | | 1.52 | 2.49 | | 0.060 | 0.098 |
| K | 9.40 | _ | - | 0.370 | - | - |
| K1 | 11.43 | _ | - | 0.450 | - | - |
| α | | 4° | 11° | | 4° | 11° |
| N | | 42 | | | 42 | |

Drawing is not to scale.

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Table 13. PDIP42 - 42 pin Plastic Dual In Line, 600 mils width, Package Mechanical Data

| | T | | | T | Secretary. | |
|------|-------|-------|-------|-------|------------|-------|
| Symb | | mm | | | inches | |
| Gy5 | Тур | Min | Max | Тур | Min | Max |
| Α | | _ | 5.08 | | - | 0.200 |
| A1 | | 0.25 | _ | | 0.010 | - |
| A2 | | 3.56 | 4.06 | | 0.140 | 0.160 |
| В | | 0.38 | 0.53 | | 0.015 | 0.021 |
| B1 | | 1.27 | 1.65 | | 0.050 | 0.065 |
| С | | 0.20 | 0.36 | | 0.008 | 0.014 |
| D | | 52.20 | 52.71 | | 2.055 | 2.075 |
| D2 | 50.80 | - | - | 2.000 | - | - |
| E | 15.24 | - | _ | 0.600 | - | - |
| E1 | | 13.59 | 13.84 | | 0.535 | 0.545 |
| e1 | 2.54 | - | _ | 0.100 | - | - |
| eA | 14.99 | - | - | 0.590 | - | - |
| eB | | 15.24 | 17.78 | | 0.600 | 0.700 |
| L | | 3.18 | 3.43 | | 0.125 | 0.135 |
| S | | 0.86 | 1.37 | | 0.034 | 0.054 |
| α | | 0° | 10° | | 0° | 10° |
| N | | 42 | • | | 42 | |

Figure 11. PDIP42 - 42 pin Plastic Dual In Line, 600 mils width, Package Outline

A2 A

B1 D2

Drawing is not to scale.

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Table 14. PLCC44 - 44 lead Plastic Leaded Chip Carrier, square, Package Mechanical Data

| Symb | mm | | | inches | | | |
|------|------|-------|-------|--------|-------|-------|--|
| | Тур | Min | Max | Тур | Min | Max | |
| А | | 4.20 | 4.70 | | 0.165 | 0.185 | |
| A1 | | 2.29 | 3.04 | | 0.090 | 0.120 | |
| A2 | | _ | 0.51 | | _ | 0.020 | |
| В | | 0.33 | 0.53 | | 0.013 | 0.021 | |
| B1 | | 0.66 | 0.81 | | 0.026 | 0.032 | |
| D | | 17.40 | 17.65 | | 0.685 | 0.695 | |
| D1 | | 16.51 | 16.66 | | 0.650 | 0.656 | |
| D2 | | 14.99 | 16.00 | | 0.590 | 0.630 | |
| E | | 17.40 | 17.65 | | 0.685 | 0.695 | |
| E1 | | 16.51 | 16.66 | | 0.650 | 0.656 | |
| E2 | | 14.99 | 16.00 | | 0.590 | 0.630 | |
| е | 1.27 | _ | - | 0.050 | _ | _ | |
| F | | 0.00 | 0.25 | | 0.000 | 0.010 | |
| R | 0.89 | _ | _ | 0.035 | - | - | |
| N | 44 | | | 44 | | | |
| CP | | | 0.10 | | | 0.004 | |

Drawing is not to scale.

Table 15. SO44 - 44 lead Plastic Small Outline, 525 mils body width, Package Mechanical Data

| Symb | | mm | | inches | | |
|------|------|-------|-------|--------|-------|-------|
| Symb | Тур | Min | Max | Тур | Min | Max |
| А | | 2.42 | 2.62 | | 0.095 | 0.103 |
| A1 | | 0.22 | 0.23 | | 0.009 | 0.010 |
| A2 | | 2.25 | 2.35 | | 0.089 | 0.093 |
| В | | | 0.50 | | | 0.020 |
| С | | 0.10 | 0.25 | | 0.004 | 0.010 |
| D | | 28.10 | 28.30 | | 1.106 | 1.114 |
| E | | 13.20 | 13.40 | | 0.520 | 0.528 |
| е | 1.27 | _ | - | 0.050 | - | - |
| Н | | 15.90 | 16.10 | | 0.626 | 0.634 |
| L | 0.80 | - | - | 0.031 | - | - |
| α | 3° | - | - | 3° | - | _ |
| N | 44 | | | 44 | | |
| СР | | | 0.10 | | | 0.004 |

Figure 13. SO44 - 44 lead Plastic Small Outline, 525 mils body width, Package Outline

Drawing is not to scale.

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